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JIN et al.(10) **Pub. No.: US 2022/0386465 A1**(43) **Pub. Date: Dec. 1, 2022**(54) **PRINTED CIRCUIT BOARD ASSEMBLY AND
ELECTRONIC DEVICE COMPRISING SAME****Publication Classification**(71) Applicant: **Samsung Electronics Co., Ltd.**,
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ABSTRACT

Disclosed is a printed circuit board assembly comprising: a first printed circuit board; a second printed circuit board stacked with the first printed circuit board; and an interposer arranged between the first printed circuit board and the second printed circuit board, wherein the second printed circuit board includes a first part and a second part extending in a first direction from a part of the first part and wherein a length of the second part in a second direction perpendicular to the first direction is less than a length in the second direction of the first part, and wherein the direction of a first conductive pattern formed on the first part and the direction of a second conductive pattern formed on the second part are substantially perpendicular to each other.

